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CHEN et al.(10) **Pub. No.: US 2022/0377938 A1**(43) **Pub. Date: Nov. 24, 2022**(54) **SUPPORT BRACKET FOR LIQUID
COOLING COLD PLATE MECHANISM****Publication Classification**(51) **Int. Cl.**
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21, 2021.(57) **ABSTRACT**

A computing system includes a chassis, a circuit board including at least one electronic component, a mounting bracket secured to the chassis, a support bracket pivotably coupled to the mounting bracket, and a cold plate coupled to the support bracket. The support bracket is pivotable between a first configuration and a second configuration. The cold plate is in contact with the at least one electronic component in the first configuration, and the cold plate is removed from contact with the at least one electronic component in the second configuration.

